

## Teseo-LIV3F GNSS Module - Hardware Manual

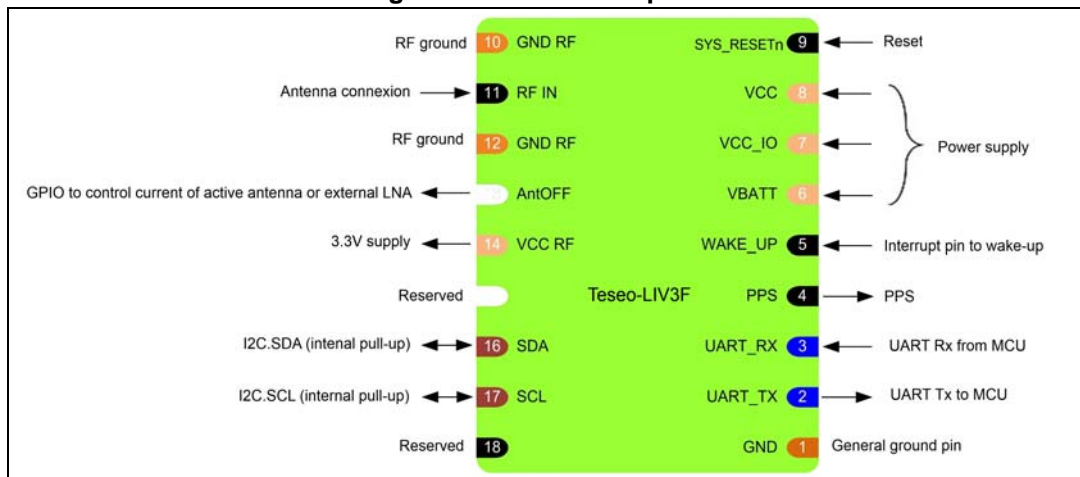
### Introduction

Teseo-LIV3F is a tiny GNSS modules sized 9.7 mm × 10.1 mm × 2.5 mm featuring STMicroelectronics® positioning receiver TeseoIII. It is a standalone positioning receiver which embeds the new ST GNSS positioning engine capable of receiving signals from multiple satellite navigation systems, including GPS, Glonass or Beidou, Galileo and QZSS.

It embeds 16M-Bit serial Flash.

In [Figure 1](#) pinout of the module.

**Figure 1. Teseo-LIV3F pinout**



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# 1 Power

Teseo-LIV3F is supplied by 3 power pins: VCC (pin8), VCC\_IO (pin7) and VBAT (pin6)

## 1.1 VCC (pin8)

VCC is the main supply.  $V_{CC}$  limiting values are: 2.1 V - 4.3 V.

A startup or during low power application current can change suddenly. It is important that supply IC is able to provide this current variation.

## 1.2 VBAT (pin6)

VBAT is the supply for the low power domain backup: backup RAM and RTC.

VBAT can be either connected to VCC or it can be supply by a dedicated supply always ON. When VBAT supply is kept ON during low power mode to allow fast recovery of GNSS fix

VBAT is preventing current flow as soon as VBAT is lower than VCC. It is important when VBAT is supplied with small battery and especially if battery is not rechargeable.

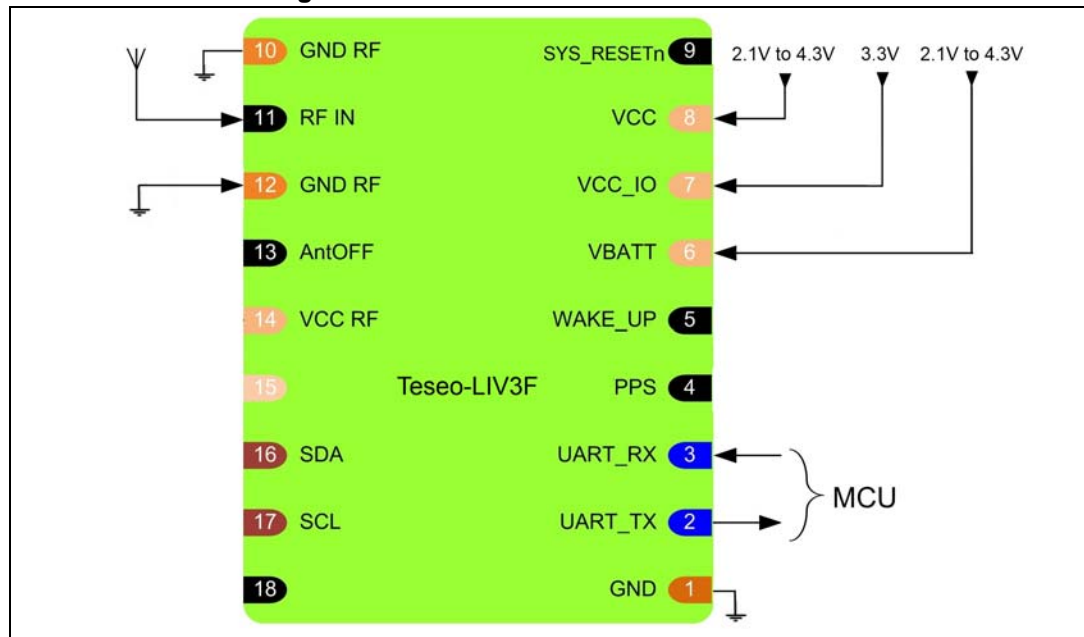
VBAT range can be from 2.1 V to 4.3 V.

## 1.3 VCC\_IO (pin7)

VCC\_IO is 3.3 V.

Figure 2 shows the minimum connection to make Teseo-LIV3F GNSS working.

Figure 2. Teseo-LIV3F minimum connection



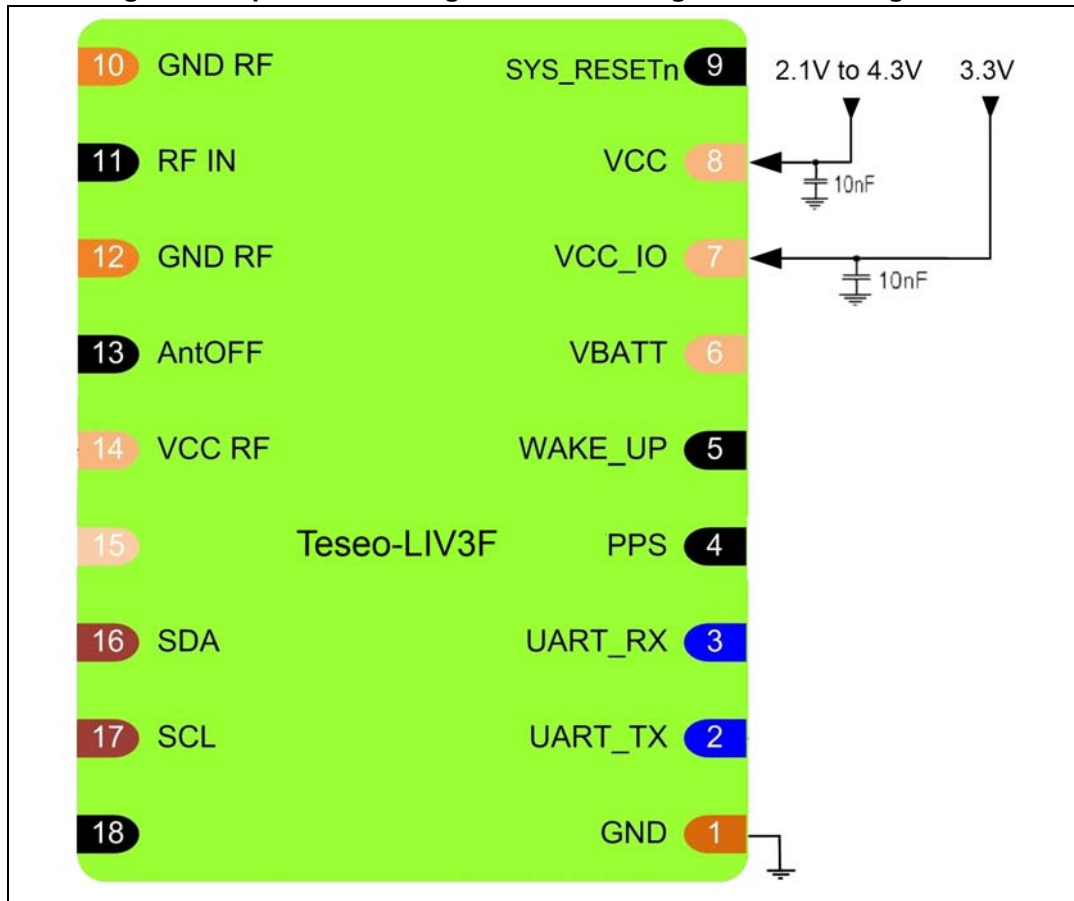
### 1.4 VCC\_RF (pin14)

VCC\_RF is an output image of VCC with a filtering for LNA or active antenna supply.

### 1.5 Power supply design reference

To reduce and filter the noise coming from the external regulator it's suggested a 10nF capacitor on VCC and VCC\_IO as shown in following picture.

Figure 3. Capacitors filtering the noise coming from externa regulators

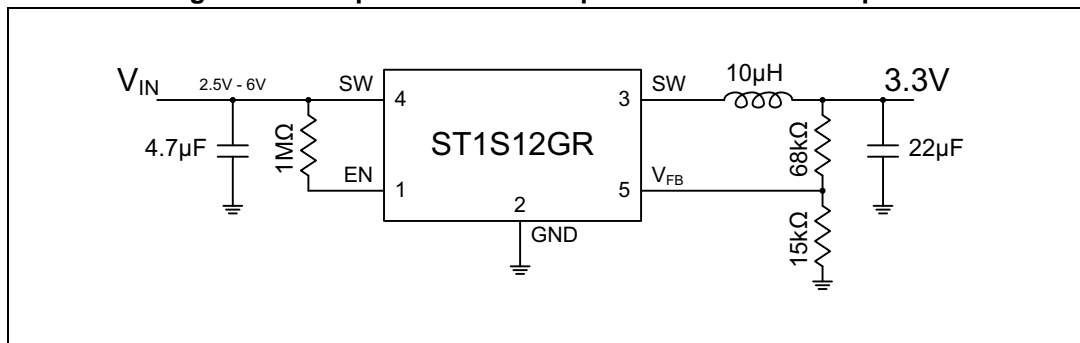


If VCC and VCC\_IO are same supplies, one capacitor only can be used.

### 1.6 Current consumption optimization

Use of an SMPS at 2.1V to supply VCC is recommended to optimize current consumption. Here is an application example with ST1S12GR with an efficiency around 85%.

Figure 4. Example of SMPS to improve current consumption



If VCC\_IO is also supplied by an SMPS, this will reach the lowest current consumption.



## 2 Reserved (pin2, 15)

In Teseo-LIV3F pin2 and pin15 are reserved.

## 3 Interfaces

### 3.1 I2C (pin16, 17)

Teseo-LIV3F supports I2C slave mode only.

Internal pull-up resistor on VCC\_IO are present. It is important to avoid to have other pull-up for current leakage in low power mode.

### 3.2 UART (pin2, 3)

UART is Universal Asynchronous Receiver/Transmitter that support much of the functionality of the industry-standard 16C650 UART.

These UARTs vary from industry-standard 16C650 on some minor points which are:

- Receive FIFO trigger levels
- The internal register map address space, and the bit function of each register differ
- The deltas of the modem status signals are not available
- 1.5 stop bits is not supported
- Independent receive clock feature is not supported

## 4 I/O pins

### 4.1 PPS (pin4)

PPS is the time pulse every one second. It can be configured with different condition of pulses.

### 4.2 Wake\_Up (pin5)

It is an external interrupt that is used to wake-up Teseo-LIV3F for asynchronous wake-up during standby software for instance.

It can be activated by a GPIO from host for instance. Wake\_Up signal is active high.

### 4.3 SYS\_RESETh (pin9)

It can force a Tese-LIV3F under reset.

Reset signal is active low.

Host processor must have full control of this pin to guarantee the Teseo-LIV3F's firmware upgrade support.

### 4.4 RF\_IN (pin10)

It is the RF input.

### 4.5 AntOFF (pin13)

AntOFF is a GPIO used to switch OFF external LNA or switch OFF current for the active antenna.

A 10kΩ pull down is necessary to ensure a low level during standby period.

## 5 Standby modes

Standby mode, is the mode where only low power backup domain is running. It means VBAT must be always maintain. It allows to have very low current consumption and fast GNSS reacquisition at the end of the standby time due to RTC.

Teseo-LIV3F offers 2 different ways of standby:

- Hardware standby
- Software standby

As IO buffers are not supplied during standby mode, it is important to keep all IO without external voltage to avoid any current leakage. UART\_RX is an exception it can be left high.

### 5.1 Software standby

Software standby is activated by the binary for periodic standby. More details how to set it are in Software Manual. As HW standby, all supplies are kept ON.

Periodic fixes are from 5s up to 24hours between 2 fixes.

It ensures a current below 20 $\mu$ A on Teseo-LIV3F. Be careful that VCC\_RF is ON during this standby, then in case of active antenna or external LNA, it is important to switch them OFF.

### 5.2 Hardware standby

This standby is ensured by switching OFF VCC (pin 6) and VCC\_IO (pin 7) supplies and setting SYS\_RESETn (pin 9) to 0 V. It can be activated asynchronously from GNSS binary with one GPIO switching OFF the supplies from a host.

During this standby only VBAT (pin 6) is kept ON.

It ensures a current below 15 $\mu$ A. During this standby mode VCC\_RF (pin 14) is OFF.

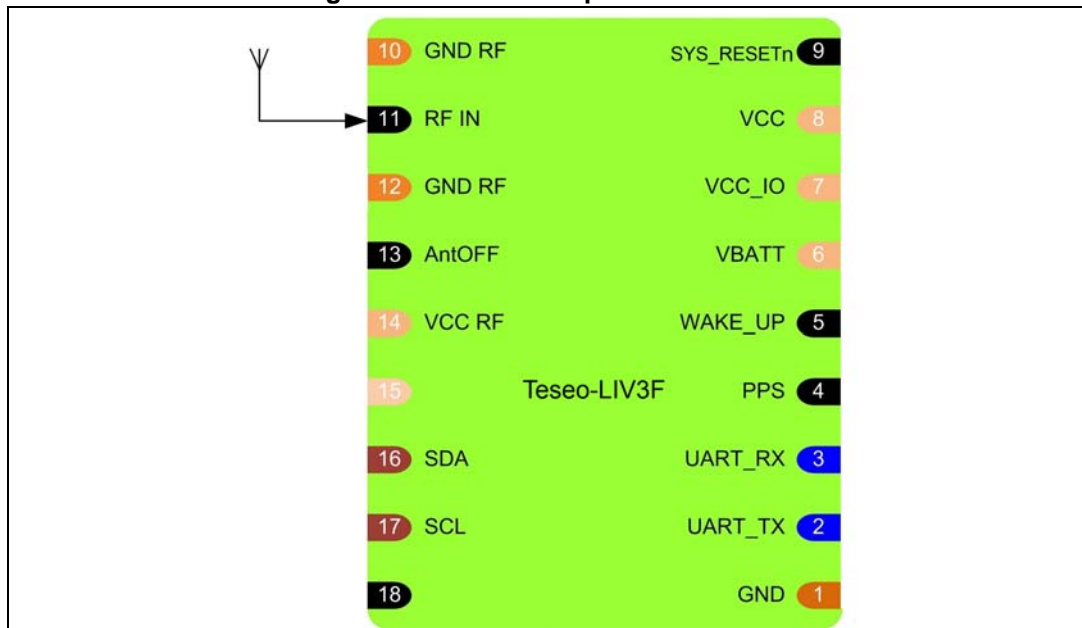
## 6 Front ends management

RF input impedance is 50  $\Omega$ .

### 6.1 Passive antenna

A passive antenna can be directly connected to Teseo-LIV3F. Take care that the antenna has to be close to the module. In addition, it could be possible that matching component must be necessary to match the antenna.

Figure 5. Teseo-LIV3F passive antenna

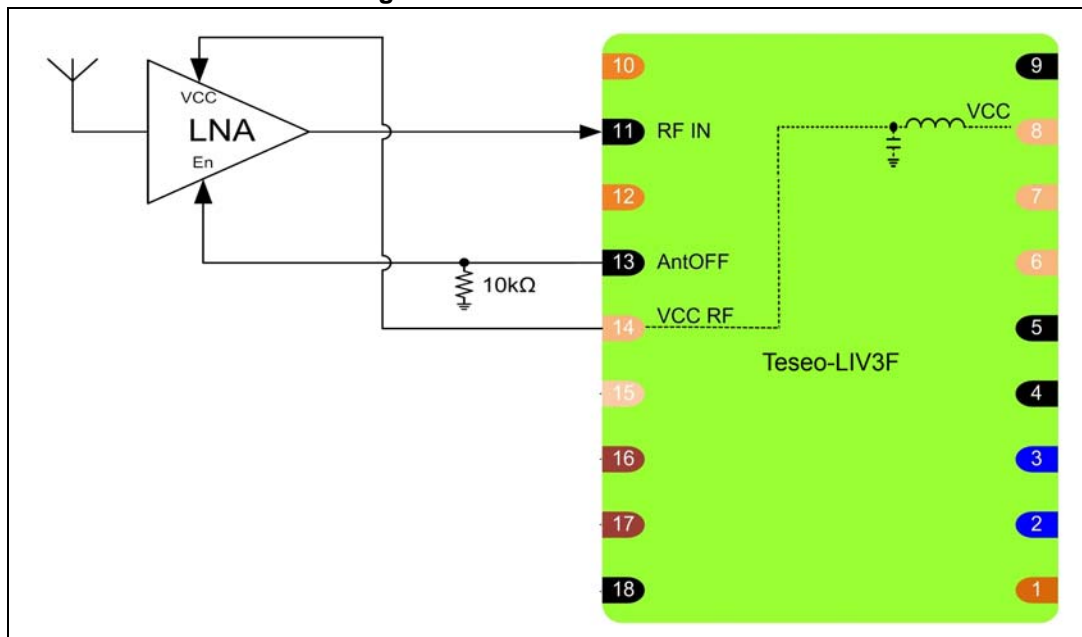


### 6.2 External LNA

External LNA means a passive antenna used with an LNA on the same PCB than Teseo-LIV3F module. To optimize power consumption during low power mode if needed, the LNA should have an enable pin compatible with VCC\_IO to be switched OFF/ON.

Here is a block diagram describing the connection:

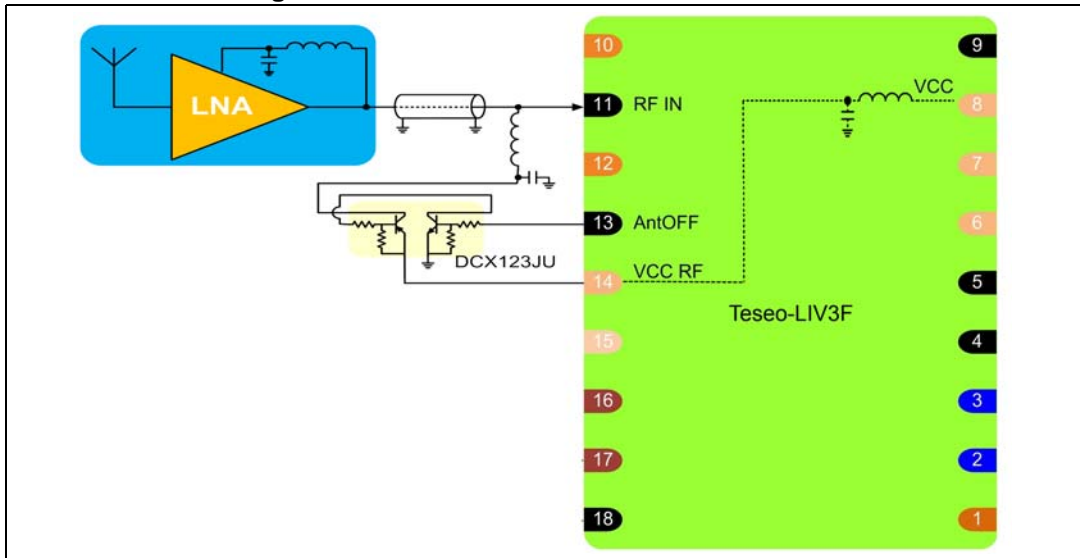
Figure 6. External LNA control



### 6.3 Active antenna

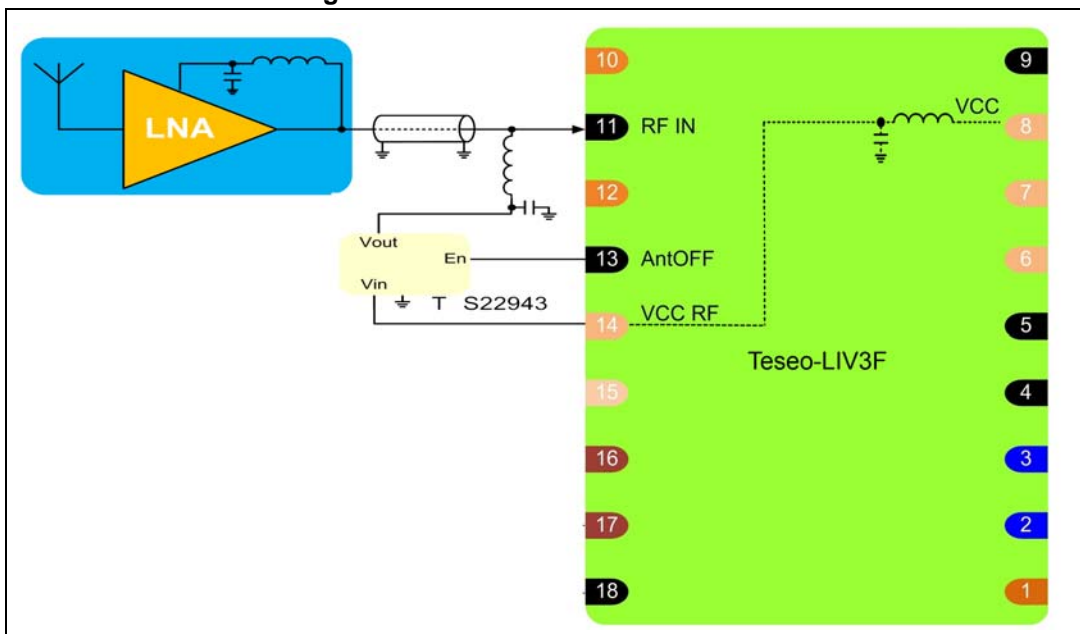
To optimize the current during low power operating mode, the active antenna can be used with a switch to cut the current flow.

Figure 7. Active antenna current switch control



To improve the functionality, a current limiter could be used in order to prevent any short circuit on the antenna see [Figure 8](#).

Figure 8. Active antenna current sense

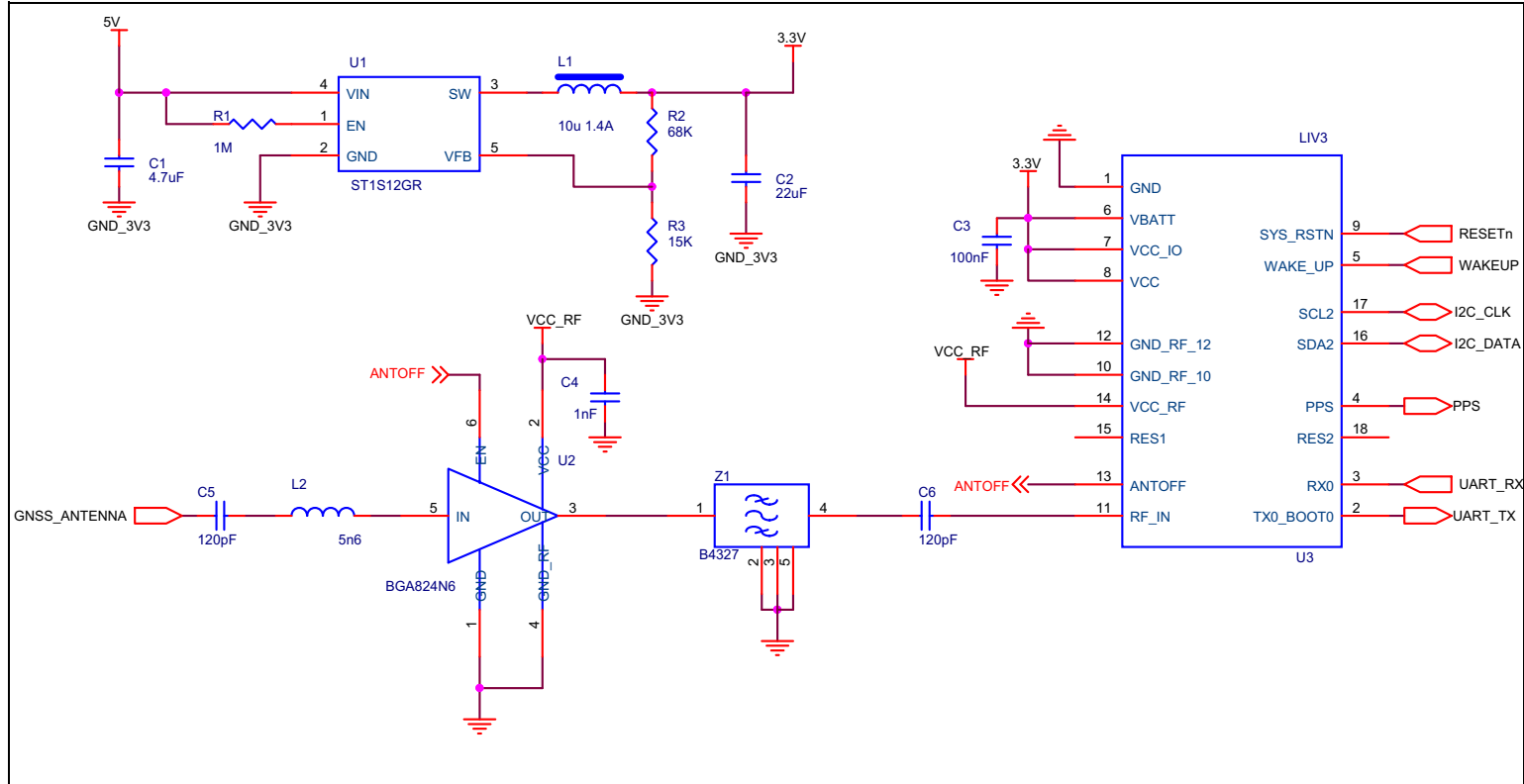




# 7 Reference schematic and BOM

## 7.1 Schematic

Figure 9. General schematic







## 7.1.1

## Bill of material

Table 1. Bill of material

Refs	Value	Description	Manufacturing 1		Manufacturing 2	
			Name	Part number	Name	Part number
C1	4u7	Surface mount 0603 capacitor ceramic 4.7uF, 10% 10V X7S 4u7; 10; X7S	Murata	GRM188C71A475KE11		
C2	22uF	Capacitor, Ceramic, SMD, MLCC, Temperature Stable, Class II, 22 uF, +/-20%, 6.3V, X5R, 0805	KEMET	C0805C226M9PACTU		
C3	100n	Surface mount, general purpose multilayer ceramic chip capacitor 100n; 50V; X7R; +/-10%	TDK	C1608X7R1H104KT	Murata	GRM188R71H104KA93
C4	1nF	Automotive Grade Surface mount 0402 capacitor ceramic 1nF, 10% 50V X7R 1nF; 50; X7R	Murata	GCM155R71H102KA37	TDK	CGA2B2X7R1H102K050BA
C5,C6	120pF	Automotive Grade Surface mount 0402 capacitor ceramic 120pF, 5% 50V C0G 120pF; 50; C0G	Murata	GCM1555C1H121JA16	TDK	CGA2B2C0G1H121J050BA
L1	10u	Surface mount magnetically shielded, wire wound inductor for power line applications. 10u; 1.4A	TDK	LTF5022T-100M1R4-LC		
L2	5n6H	Surface mount wire wound inductor. 5n6H; 3%; 0.76A	Coilcraft	0402CS-5N6XJLU	Murata	LQW15AN5N6G80D+00-21
R1	1M	Surface mount chip resistor 1M; 5%; 0.1W	Rohm	MCR03EZPJ105		
R2	68K	Surface mount chip resistor 68K; 1%; 0.1W	Rohm	MCR03EZPF683		
R3	15K	Surface mount chip resistor 15K; 1%; 0.1W	Rohm	MCR03EZPF153	Yageo	AC0603FR-0715KL
U1	ST1S12GR	Synchronous rectification adjustable step-down switching regulator ST1S12GR; 0.7; 1.7	STMicroelectronics	ST1S12GR TSOT23-5L		
U2	BGA824N6	Low Noise Amplifier for GPS, GLONASS, Galileo and Compass BGA824N6	Infineon	BGA824N6		
Z1	B4327	Automotive SAW RF filter for GPS+COMPASS+GLONASS	Epcos	B39162B4327P810		
U3	LIV	TESEOIII module SMPS version	STMicroelectronics	LIV3F		

## 8 Revision history

Table 2. Document revision history

Date	Revision	Changes
08-Sep-2017	1	Initial release.

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